

<b>Notice of References Cited</b>	Application/Control No. 10/730,834	Applicant(s)/Patent Under Reexamination KUO ET AL.	
	Examiner Leonardo Andújar	Art Unit 2826	Page 1 of 1

**U.S. PATENT DOCUMENTS**

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
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*	B	US-6,511,901	01-2003	Lam et al.	438/612
*	C	US-5,646,439	07-1997	Kitayama et al.	257/632
*	D	US-4,051,508	09-1977	Sato et al.	257/737
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	J	US-			
	K	US-			
	L	US-			
	M	US-			

**FOREIGN PATENT DOCUMENTS**

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	N					
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**NON-PATENT DOCUMENTS**

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	Harper, Electronic Packaging Interconnection Handbook, 1991, McGraw-Hill, 5.1-5.22
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\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)  
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.